



Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: **L-0412-02** DATE: 12/8/2004
 Product Affected: Please see below "Description and Purpose of Change" section
 Date Effective: January 31, 2005

MEANS OF DISTINGUISHING CHANGED DEVICES:
 Product Mark
 Back Mark
 Date Code
 Other Quantity change on the reel

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Attachment: Yes No
 Samples: N/A

DESCRIPTION AND PURPOSE OF CHANGE:

- Die Technology
- Wafer Fabrication Process For devices in BF96/BFG96 package (96-pin CABGA), Tape-&-Reel quantity will increase from 2,000 units per reel to 3,000 units per reel.
- Assembly Process
- Equipment
- Material There is no change in Tape-&-Reel design, material and dimension.
- Testing
- Manufacturing Site Affected products are as follow:
- Data Sheet IDT74SSTU32864, IDT74SSTU32864A, IDT74SSTU32864C, IDT74SSTU32864D, IDT74SSTU32864G, IDT74SSTU32866B, IDT74ALVCH32244, IDT74ALVCH32245, IDT74ALVCH32373, IDT74ALVCH32374, IDT74AUC32245, IDT74LVCH32244A, IDT74LVCH32245A, IDT5V9955 & IDT5T9955
- Other

RELIABILITY/QUALIFICATION SUMMARY:

There is no change in quality and reliability of the affected parts.

CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.
 IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: _____ **Approval for shipments prior to effective date.**
 Name/Date: _____ E-Mail Address: _____
 Title: _____ Phone# /Fax# : _____

CUSTOMER COMMENTS: _____

IDT ACKNOWLEDGMENT OF RECEIPT:

RECD. BY: _____ DATE: _____